

TOSHIBA Photocoupler GaAs Ired &amp; Photo-Transistor

# TLP620, TLP620-2, TLP620-4

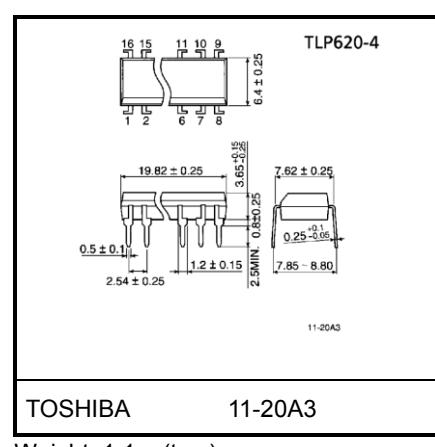
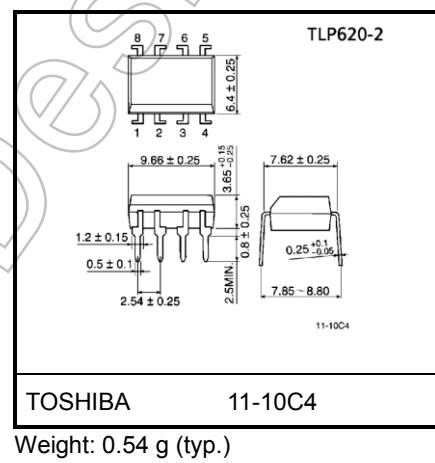
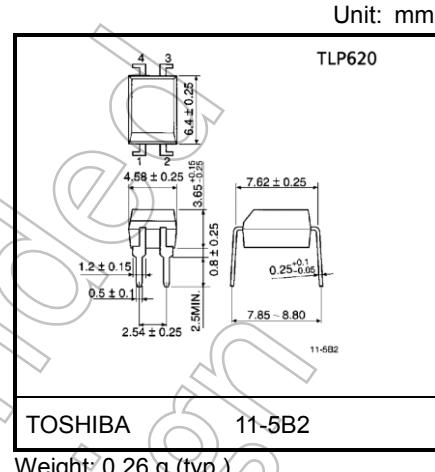
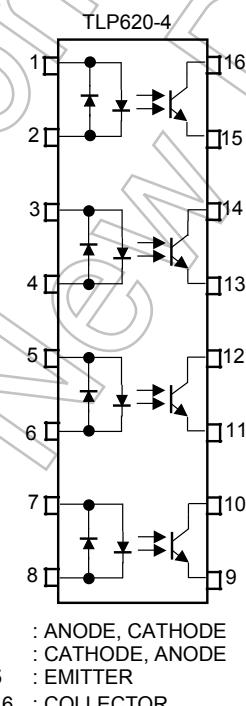
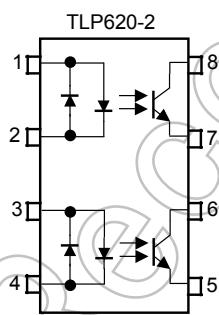
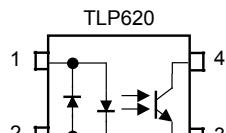
Programmable Controllers  
AC / DC-Input Module  
Telecommunication

The TOSHIBA TLP620, -2 and -4 consists of a photo-transistor optically coupled to two gallium arsenide infrared emitting diode connected in inverse parallel.

The TLP620-2 offers two isolated channels in an eight lead plastic DIP, while the TLP620-4 provides four isolated channels in a sixteen lead plastic DIP.

- Collector-emitter voltage: 55V (min.)
- Current transfer ratio: 50% (min.)
- Rank GB: 100% (min.)

## Pin Configurations (top view)



Start of commercial production  
1984-01

- Isolation voltage: 5000Vrms (min.)
- Safety Standards
- UL recognized : UL1577, File No. E67349
- cUL recognized : CSA Component Acceptance Service No. 5A  
File No. E67349
- SEMKO approved : No.9808210/01-03
- EN60065, EN60950 (approved TLP620 and TLP620-2)
- Option (D4) type  
VDE approved : EN60747-5-5  
Maximum operating insulation voltage: 890 VPK  
Highest permissible over voltage: 8000 VPK

**Note: When an EN 60747-5-5 approved type is needed,  
please designate the “Option(D4)”.**

Construction Mechanical Rating

- Creepage distance : 6.4 mm (min)
- Clearance : 6.4 mm (min)
- Insulation thickness : 0.4 mm (min)

## Absolute Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating		Unit
		TLP620	TLP620-2 TLP620-4	
LED	Forward current	I <sub>F</sub> (RMS)	60	50
	Forward current derating	ΔI <sub>F</sub> /°C	-0.7 (Ta ≥ 39°C)	mA/°C
	Pulse forward current (Note 1)	I <sub>FP</sub>	1	A
	Power dissipation (1 circuit)	P <sub>D</sub>	100	mW
	Power dissipation derating (1 circuit)	ΔP <sub>D</sub> /°C	-1.2 (Ta ≥ 39°C)	mW/°C
	Junction temperature	T <sub>j</sub>	125	°C
Detector	Collector-emitter voltage	V <sub>C EO</sub>	55	V
	Emitter-collector voltage	V <sub>E CO</sub>	7	V
	Collector current	I <sub>C</sub>	50	mA
	Collector power dissipation (1 circuit)	P <sub>C</sub>	150	mW
	Collector power dissipation derating (Ta ≥ 25°C) (1 circuit)	ΔP <sub>C</sub> /°C	-1.5	mW/°C
	Junction temperature	T <sub>j</sub>	125	°C
Storage temperature range	T <sub>stg</sub>	-55 to 125		°C
Operating temperature range	T <sub>opr</sub>	-55 to 100		°C
Lead soldering temperature (10 s)	T <sub>sol</sub>	260		°C
Total package power dissipation (1 circuit)	P <sub>T</sub>	250	150	mW
Total package power dissipation derating (Ta ≥ 25°C) (1 circuit)	ΔP <sub>T</sub> /°C	-2.5	-1.5	mW/°C
Isolation voltage (Note 2)	BVs	5000		V <sub>rms</sub>

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 1: 100 μs pulse, 100 pps

Note 2: AC, 1 min., RH ≤ 60%

Device considered a two terminal device: LED side pins shorted together and DETECTOR side pins shorted together.

## Recommended Operating Conditions

Characteristic	Symbol	Min	Typ.	Max	Unit
Supply voltage	V <sub>CC</sub>	—	5	24	V
Forward current	I <sub>F</sub> (RMS)	—	16	25	mA
Collector current	I <sub>C</sub>	—	1	10	mA
Operating temperature	T <sub>OPR</sub>	-25	—	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

## Electrical Characteristics (Ta = 25°C)

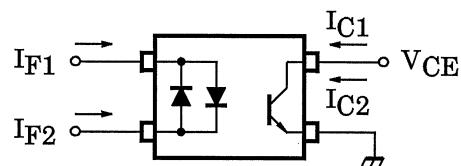
Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	V <sub>F</sub>	I <sub>F</sub> = ±10 mA	1.0	1.15	1.3	V
	Forward current	I <sub>F</sub>	V <sub>F</sub> = ±0.7 V	—	2.5	20	μA
	Capacitance	C <sub>T</sub>	V = 0 V, f = 1 MHz	—	60	—	pF
Detector	Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	I <sub>C</sub> = 0.5 mA	55	—	—	V
	Emitter-collector breakdown voltage	V <sub>(BR)ECO</sub>	I <sub>E</sub> = 0.1 mA	7	—	—	V
	Collector dark current	I <sub>CEO</sub>	V <sub>CE</sub> = 24 V	—	10	100	nA
			V <sub>CE</sub> = 24 V, Ta = 85 °C	—	2	50	μA
	Capacitance (collector to emitter)	C <sub>CE</sub>	V = 0 V, f = 1 MHz	—	10	—	pF

## Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Current transfer ratio	I <sub>C</sub> /I <sub>F</sub>	I <sub>F</sub> = ±5 mA, V <sub>CE</sub> = 5 V	50	—	600	%
			100	—	600	
Saturated CTR	I <sub>C</sub> /I <sub>F(sat)</sub>	I <sub>F</sub> = ±1 mA, V <sub>CE</sub> = 0.4 V	—	60	—	%
			30	—	—	
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = 2.4 mA, I <sub>F</sub> = ±8 mA	—	—	0.4	V
		I <sub>C</sub> = 0.2 mA, I <sub>F</sub> = ±1 mA	—	0.2	—	
		Rank GB	—	—	0.4	
Off-state collector current	I <sub>C(off)</sub>	V <sub>F</sub> = ±0.7 V, V <sub>CE</sub> = 24 V	—	1	10	μA
CTR symmetry (Note 1)	I <sub>C</sub> (ratio)	I <sub>C</sub> (I <sub>F</sub> = -5mA) / I <sub>C</sub> (I <sub>F</sub> = +5mA)	0.33	—	3	—

Note 1:

$$I_C(\text{ratio}) = \frac{I_{C2}(I_F = I_{F2}, V_{CE} = 5V)}{I_{C1}(I_F = I_{F1}, V_{CE} = 5V)}$$



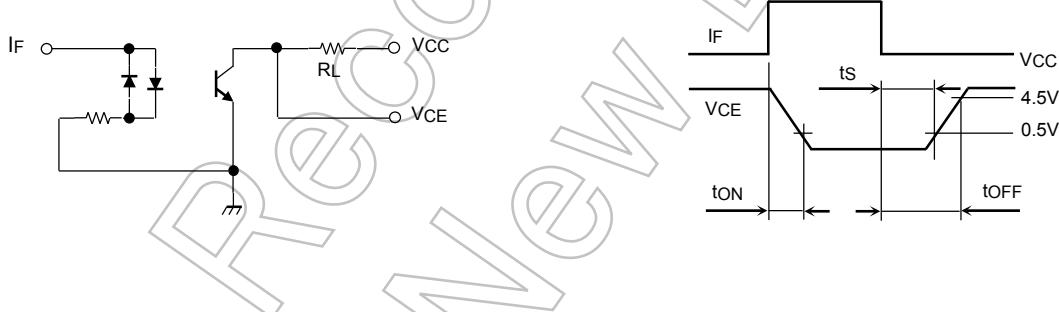
## Isolation Characteristics (Ta = 25°C)

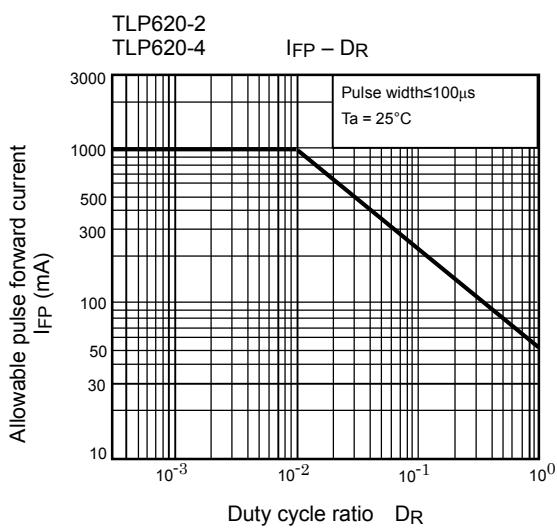
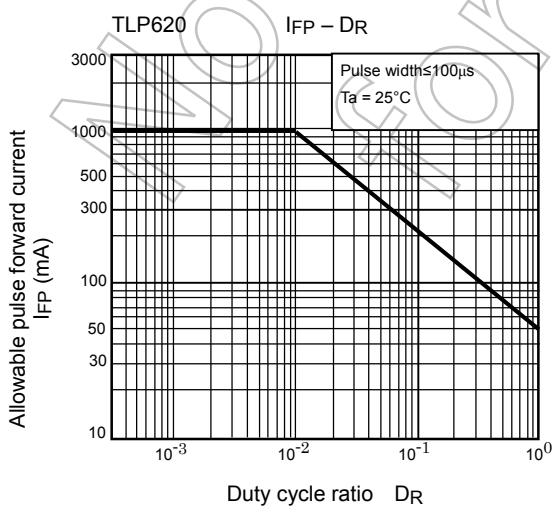
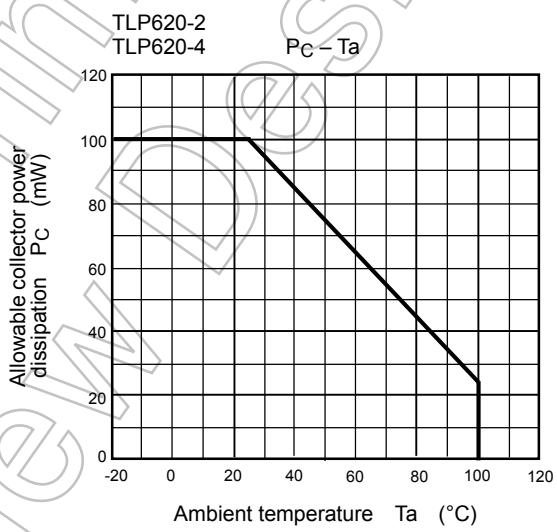
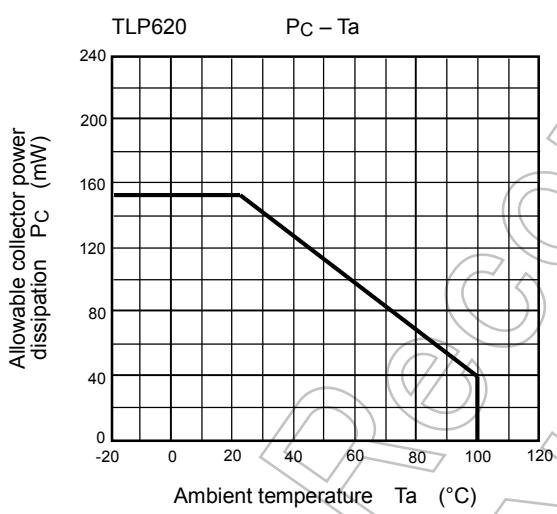
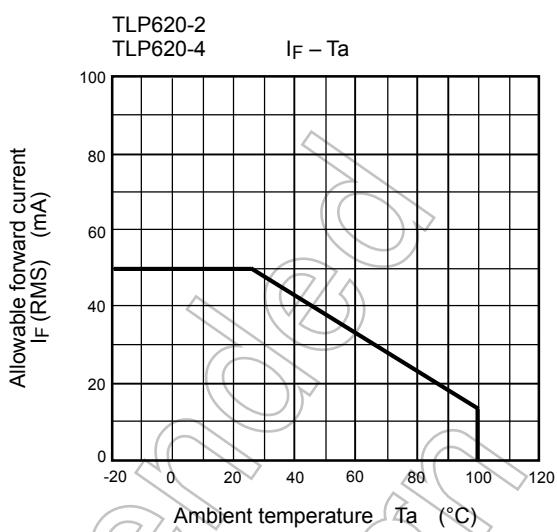
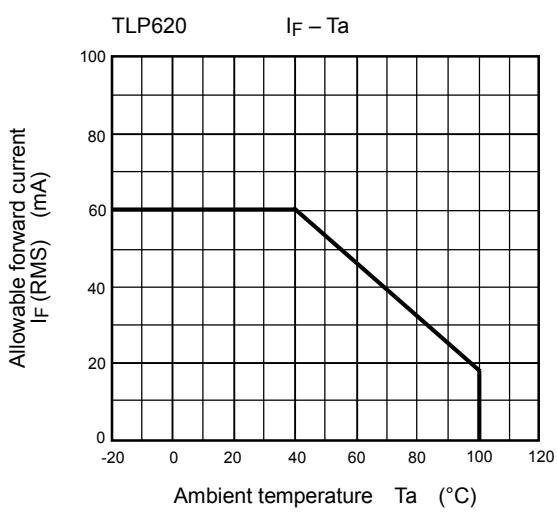
Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Capacitance input to output	C <sub>S</sub>	V <sub>S</sub> = 0 V, f = 1MHz	—	0.8	—	pF
Isolation resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H.≤60%	1×10 <sup>12</sup>	10 <sup>14</sup>	—	Ω
Isolation voltage	B <sub>VS</sub>	AC, 60 s	5000	—	—	V <sub>rms</sub>
		AC, 1 s, in oil	—	10000	—	
		DC, 60 s, in oil	—	10000	—	V <sub>dc</sub>

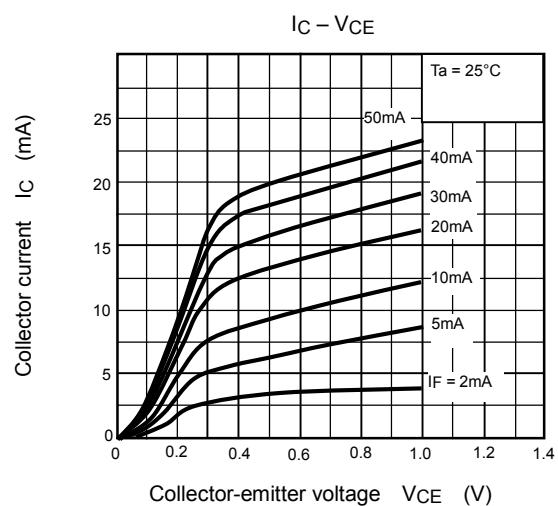
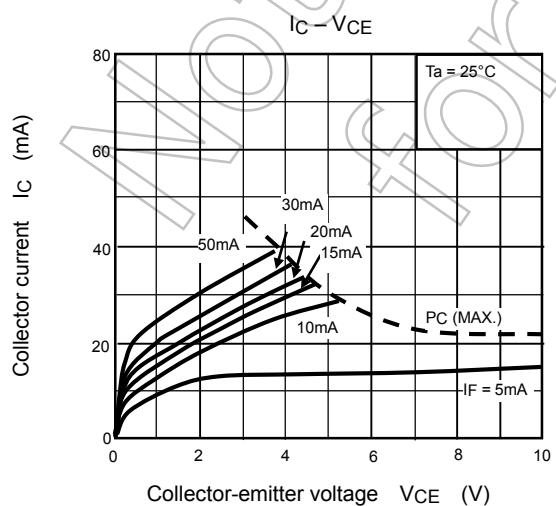
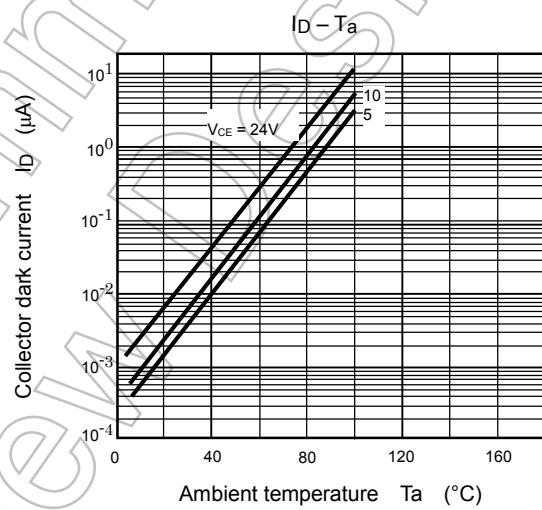
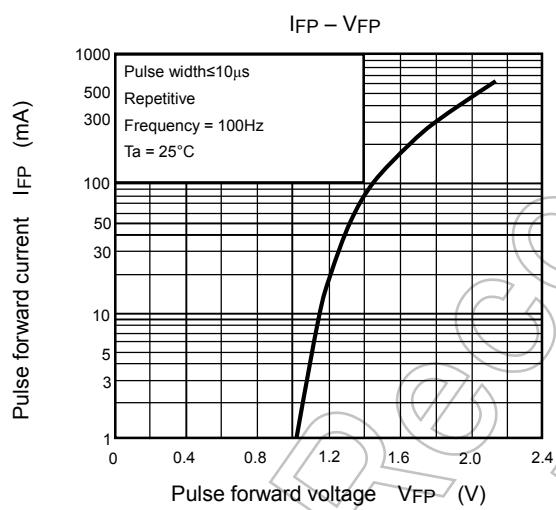
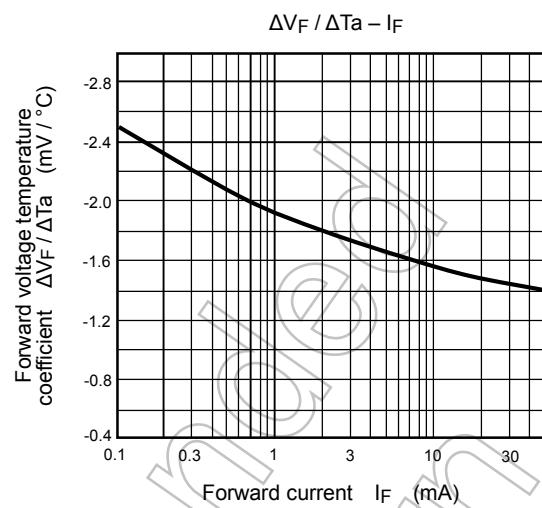
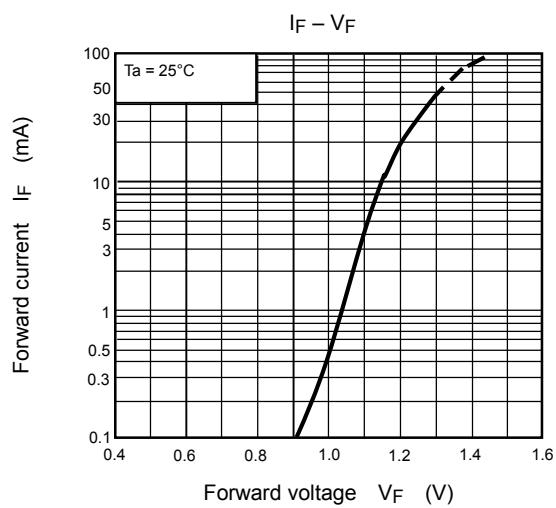
## Switching Characteristics (Ta = 25°C)

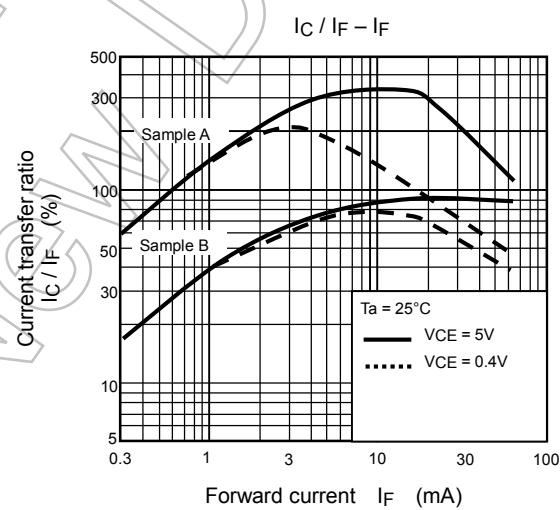
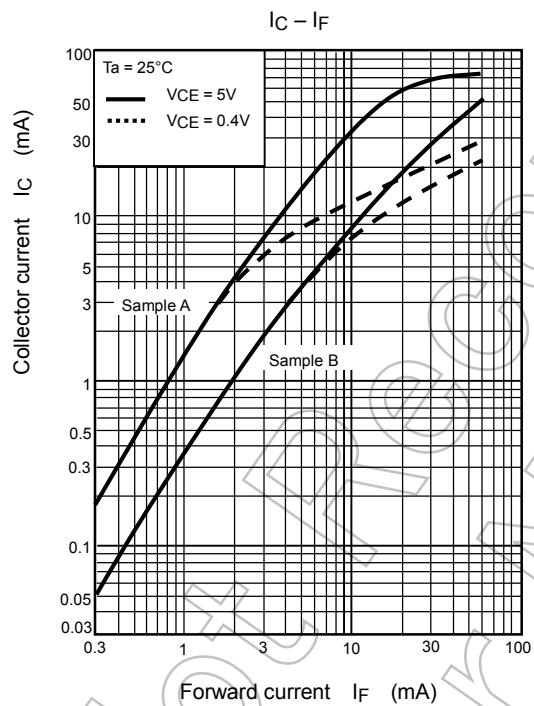
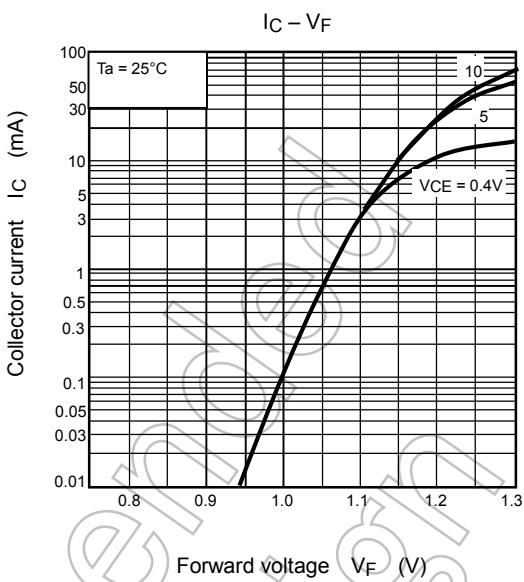
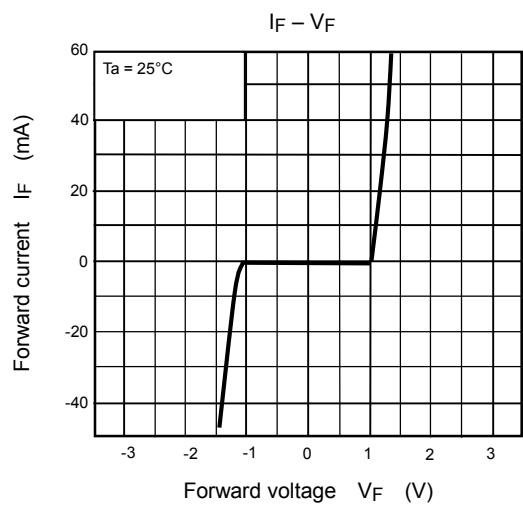
Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Rise time	t <sub>r</sub>	V <sub>CC</sub> = 10 V, I <sub>C</sub> = 2 mA R <sub>L</sub> = 100 Ω	—	2	—	μs
Fall time	t <sub>f</sub>		—	3	—	
Turn-on time	t <sub>on</sub>		—	3	—	
Turn-off time	t <sub>off</sub>		—	3	—	
Turn-on time	t <sub>ON</sub>	R <sub>L</sub> = 1.9 kΩ V <sub>CC</sub> = 5 V, I <sub>F</sub> = ±16 mA (Fig.1)	—	2	—	μs
Storage time	t <sub>s</sub>		—	15	—	
Turn-off time	t <sub>OFF</sub>		—	25	—	

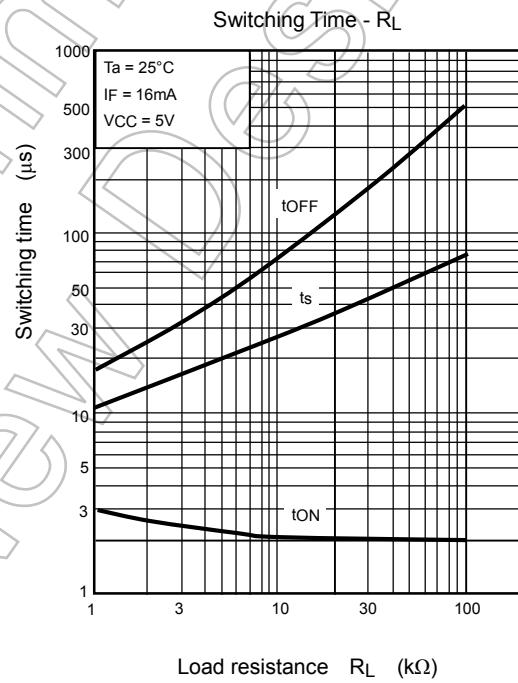
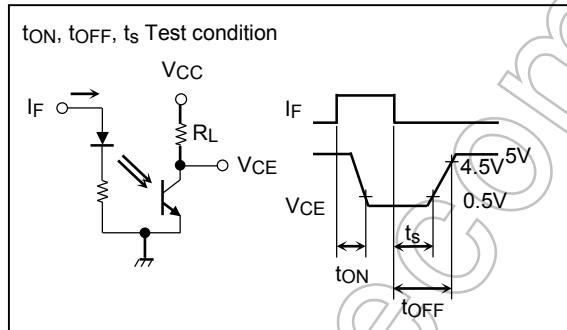
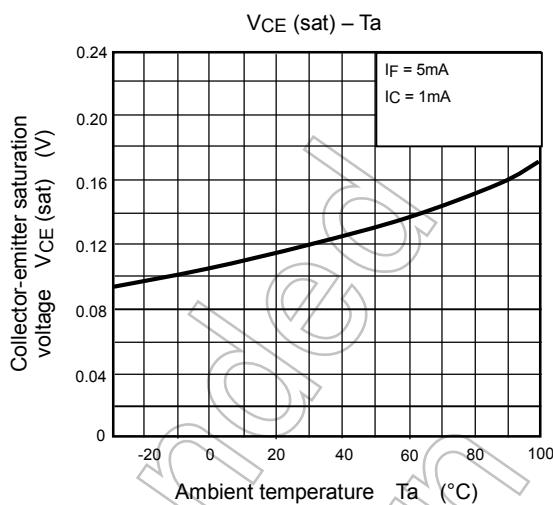
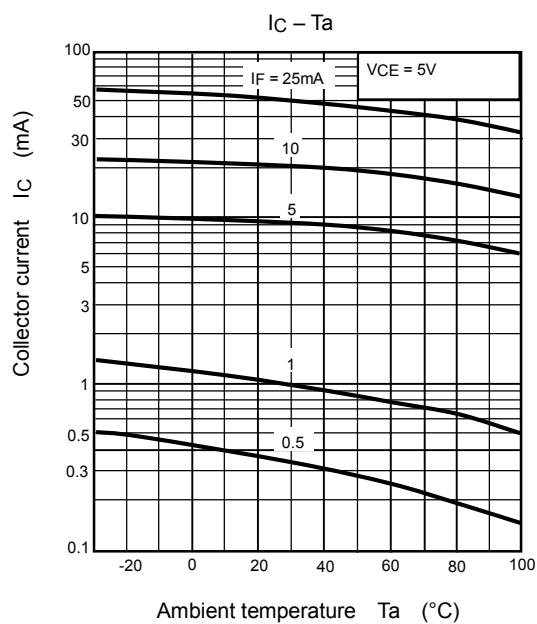
Fig. 1 Switching time test circuit











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